



**CHENMKO ENTERPRISE CO.,LTD**

Halogens free devices

### SURFACE MOUNT

SCHOTTKY BARRIER DIODE

VOLTAGE 40 Volts CURRENT 0.1 Ampere

**CH425DGP**

#### APPLICATION

- \* Low power rectification

#### FEATURE

- \* Small surface mounting type. (SOT-23)
- \* Low VF. (VF=0.45V Typ. at 100mA)
- \* High reliability

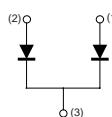
#### CONSTRUCTION

- \* Silicon epitaxial planar

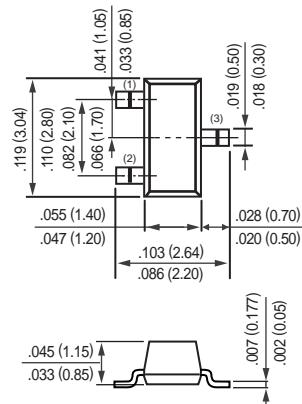
#### MARKING

- \* KL4

#### CIRCUIT



**SOT-23**



Dimensions in millimeters

**SOT-23**

#### MAXIMUM RATINGS ( At TA = 25°C unless otherwise noted )

RATINGS	SYMBOL	CH425DGP	UNITS
Maximum Recurrent Peak Reverse Voltage	VR <sub>RM</sub>	40	Volts
Maximum RMS Voltage	V <sub>RMS</sub>	28	Volts
Maximum DC Blocking Voltage	V <sub>D</sub> C	40	Volts
Maximum Average Forward Rectified Current	I <sub>O</sub>	0.1	Amps
Peak Forward Surge Current at 8.3 mSec single half sine-wave	I <sub>FSM</sub>	1.0	Amps
Typical Junction Capacitance between Terminal (Note 1)	C <sub>J</sub>	6.0	pF
Maximum Operating Temperature Range	T <sub>J</sub>	+125	°C
Storage Temperature Range	T <sub>STG</sub>	-40 to +125	°C

#### ELECTRICAL CHARACTERISTICS ( At TA = 25°C unless otherwise noted )

CHARACTERISTICS	SYMBOL	CH425DGP	UNITS
Maximum Instantaneous Forward Voltage at I <sub>F</sub> (1)= 10mA	V <sub>F</sub> (1)	0.34	Volts
Maximum Instantaneous Forward Voltage at I <sub>F</sub> (2)= 100mA	V <sub>F</sub> (2)	0.55	Volts
Maximum Average Reverse Current at V <sub>R</sub> = 10V	I <sub>R</sub>	30	uAmps

NOTES : 1. Measured at 1.0 MHz and applied reverse voltage of 10.0 volts.  
2. ESD sensitive product handling required.

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## RATING CHARACTERISTIC CURVES ( CH425DGP)

FIG. 1 - FORWARD CHARACTERISTICS

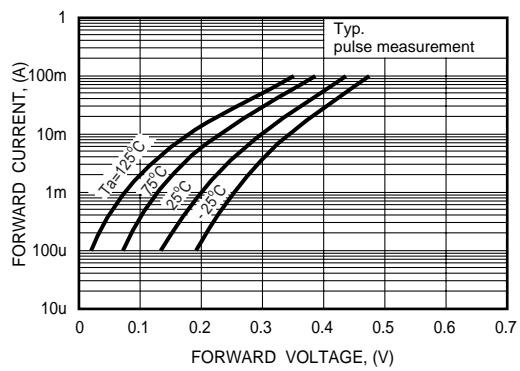


FIG. 2 - REVERSE CHARACTERISTICS

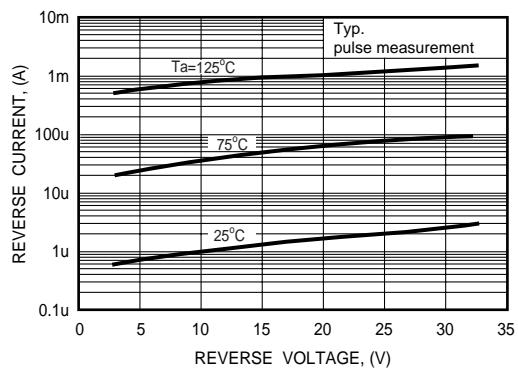


FIG. 3 - TYPICAL JUNCTION CAPACITANCE

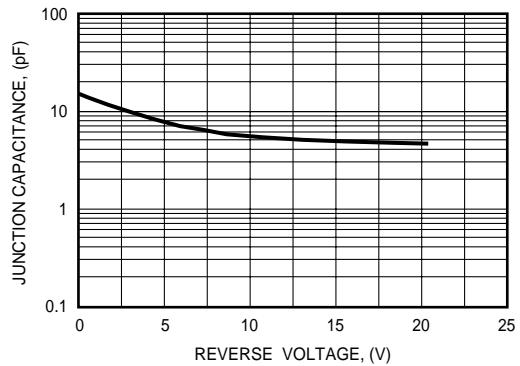


FIG. 4 - TYPICAL FORWARD CURRENT DERATING CURVE

